

ICEEI 2022

Hanoi, Vietnam
December 16–18, 2022



PUBLICATION

After a careful reviewing process, all accepted papers after proper registration and presentation will be published in the Conference Proceedings which will be included in the major database, Ei Compendex and Scopus, etc.

The accepted papers of ICEEI 2019–2021 have been indexed by Ei compendex and Scopus.

SUBMISSION

- Full Paper (publication and oral presentation)
- Abstract (oral presentation only)
- Electronic Submission System (.pdf)
<http://confsys.iconf.org/submission/iceei2022>
- Email submission: iceei2019@zhconf.ac.cn
- Paper Template: <http://iceei.net/Paper-format.docx>

IMPORTANT DATE

- Submission Deadline: July 25, 2022
- Notification Date: August 15, 2022
- Registration Deadline: August 30, 2022 (Early Bird)

ICEEI 2019–2021 have been held successfully in Seoul 2019 and online in 2020, 2021 separately. 2022 4th International Conference on Engineering Education and Innovation (ICEEI 2022) will take place in Hanoi, Vietnam during December 16–18, 2022, co-sponsored by Vietnam Institute of Building Materials, technical supported by Innovation Centre for Engineering Education at Seoul National University.

CALL FOR PAPERS

- Architectural Engineering
- Biomedical Engineering
- Chemical Engineering
- Civil Engineering
- Computer Engineering
- Electrical Engineering
- Electronics Engineering
- Material Engineering
- Mechanical Engineering
- Naval Engineering
- Ocean Engineering
- Production Engineering
- Sustainable Engineering
- Creative Thinking
- Design Thinking
- Washington Accord
- Assessments
- Communications
- Curriculum
- Distance Education
- Diversity
- Educational Methods
- Industrial Partnerships
- Retention
- Web Technology
- Entrepreneurship

More topics: <http://www.iceei.net/cfp.html>

COMMITTEES

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